

Complete early redemption by Modivo S.A. of bonds issued to SoftBank**(Current report No. 50/2025)**

12.06.2025 /the Issuer/

Legal basis:

Article 17 sec. 1 MAR - confidential information

With reference to Current Report No. 64/2021 dated October 5, 2021 (Issuance of convertible bonds worth PLN 500 million by eobuwie.pl S.A. to an entity related to SoftBank Vision Fund 2) and Current Report No. 45/2025 dated June 4, 2025 (Conclusion by Modivo S.A. of a credit agreement regarding the granting of financing up to PLN 660,000,000 with UniCredit S.p.A. for the redemption of bonds issued for SoftBank and the related annex to the credit agreement with Powszechna Kasa Oszczędności Bank Polski S.A.), CCC S.A. with its registered office in Polkowice ("CCC") hereby announces that Modivo S.A. with its registered office in Zielona Góra ("Modivo"), a subsidiary of CCC, on June 12, 2025, in exercise of its right, made an early full redemption, along with interest, of bonds with a total nominal value of PLN 500 million, issued by Modivo on October 5, 2021 and acquired by SVF II Motion SubCo (DE) LLC, an entity from the SoftBank Group, referred to in Current Report No. 43/2021 dated July 2, 2021, Current Report No. 44/2021 dated July 2, 2021, Current Report No. 64/2021 dated October 5, 2021 and Current Report No. 58/2023 dated November 24, 2023.

The redemption of the Bonds was financed by a term loan granted to Modivo under the credit agreement by UniCredit S.p.A., referred to in Current Report No. 45/2025, and by Modivo's own funds. This is the final element of the Issuer's capital group's consistently implemented debt refinancing program, aimed at optimizing its financing structure and significantly reducing the cost of debt.

*Signatures:**2/ Łukasz Stelmach - Vice-President of the Management Board**2/ Hanna Kamińska - Proxy*